507568771 10/28/2022

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE: NEW ASSIGNMENT NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
GUANGBIN ZHOU	09/13/2022
HIROSHI SUZUKI	09/13/2022
GOROU YOSHIDA	09/13/2022
KAZUHIRO TANAKA	09/22/2022

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17997382

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 072388.1573 NAME OF SUBMITTER: HIROKO LAVIETES **SIGNATURE:** /Hiroko Lavietes/ **DATE SIGNED:** 10/28/2022

Total Attachments: 1

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PATENT **REEL: 061576 FRAME: 0743** 507568771

ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me by Hitachi High-Tech Corporation, a corporation organized under the laws of Japan, located at 17-1, Toranomon 1-chome, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Tech Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SOLENOID VALVE ABNORMALITY DETECTION DEVICE, AUTOMATIC MEDICAL ANALYSIS APPARATUS USING SAME, AND SOLENOID VALVE ABNORMALITY DETECTION METHOD

Invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Tech Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Tech Corporation,

Signed on the date(s) indicated aside signatures:

		INVENTOR(S)	Date Signed
		(発明者フルネームサイン)	(署名日)
1)	Guangbin ZHOU	Guangbin Zhou	9/13/2022
2)	Hiroshi SUZUKI	Hiroshi Lunuk	9/13/2022
3)	Gorou YOSHIDA	Hirosti Luzuki Gorou Yoshida	9/13/2022
4)	Kazuhiro TANAKA	Kazuhiro Tanaka	9/22/2022
5)	V		
6)			
7)			
8)			
9)			
10)			

PATENT REEL: 061576 FRAME: 0744

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